

2-382719-1 Information

Part Number 2-382719-1

Manufacturer TE Connectivity AMP Connectors

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN IC DIP SOCKET 30POS TIN

Package

For the pricing/inventory/lead time, please contact

Website: https://www.heisener.com For Reference Only

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









2-382719-1 Specifications

Manufacturer Part Number	2-382719-1
Manufacturer	TE Connectivity AMP Connectors
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	Diplomate DL
Туре	DIP, 0.6" (15.24mm) Row Spacing
Number of Positions or Pins (Grid)	30 (2 x 15)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Tin
Contact Finish Thickness - Mating	-
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Open Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	-
Contact Material - Post	Beryllium Copper
Housing Material	Thermoplastic, Glass Filled
Operating Temperature	-55°C ~ 105°C
	Report errors?

2-382719-1 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

2-382719-1 Payment Methods



















2-382719-1 Shipping Methods













If you have any question about 2-382719-1, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com